

## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>RM</sub>	60	٧
Average Rectified Output Current	lo	500	mA
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	15	Α

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Ambient Air (Note 6) Thermal Resistance Junction to Ambient Air (Note 7)	$R_{ heta JA} \ R_{ heta JA}$	305 271	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage (Per Diode)	V <sub>F</sub>	-	- 0.44 -	0.44 0.50 0.46	٧	I <sub>F</sub> = 0.25A, T <sub>J</sub> = +25°C I <sub>F</sub> = 0.5A, T <sub>J</sub> = +25°C I <sub>F</sub> = 0.5A, T <sub>J</sub> = +125°C
Leakage Current (Note 8)	I <sub>R</sub>	-	-	100 25	μA mA	$V_R = 60V, T_J = +25^{\circ}C$ $V_R = 60V, T_J = +125^{\circ}C$

Notes:

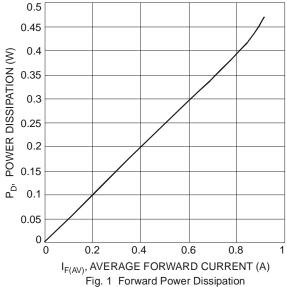
<sup>6.</sup> Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

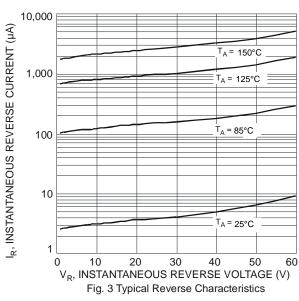
<sup>7.</sup> Part mounted on Polymide board with recommended pad layout, which can be found on our website at http://www.diodes.com/nackage.outlines.html

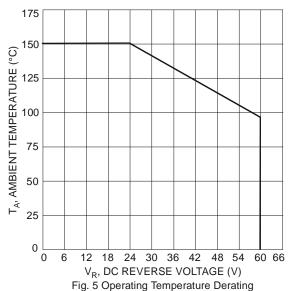
http://www.diodes.com/package-outlines.html.

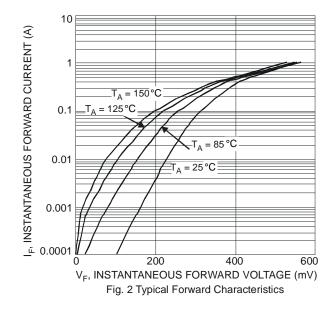
8. Short duration pulse test used to minimize self-heating effect.

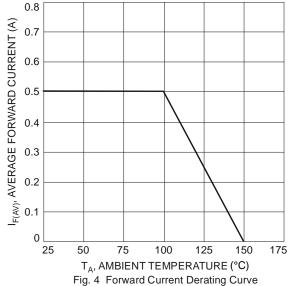










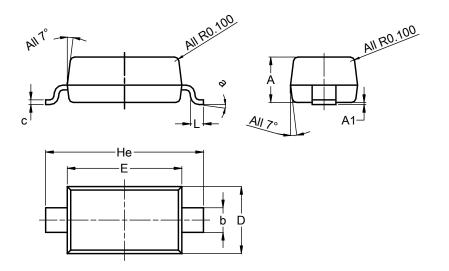




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOD123

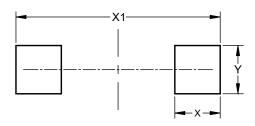


SOD123					
Dim	Min	Max	Тур		
Α	1.00	1.35	1.05		
A1	0.00	0.10	0.05		
b	0.52	0.62	0.57		
С	0.10	0.15	0.11		
D	1.40	1.70	1.55		
Е	2.55	2.85	2.65		
He	3.55	3.85	3.65		
L	0.25	0.40	0.30		
а	00	8°			
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOD123



Dimensions	Value (in mm)
Х	0.900
X1	4.050
Y	0.950



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